



DMP45H4D9HK3

### **Product Summary**

| BV <sub>DSS</sub> | RDS(ON) Max                   | I <sub>D</sub><br>Tc = +25°С |
|-------------------|-------------------------------|------------------------------|
| -450V             | 4.9Ω @ V <sub>GS</sub> = -10V | -4.7A                        |

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor Control
- DC-DC Converters
- Power Management Functions
- Uninterrupted Power Supply

#### 450V P-CHANNEL ENHANCEMENT MODE MOSFET

#### **Features**

- Low Input Capacitance
- High BV<sub>DSS</sub> Rating for Power Application
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

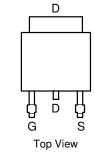
### **Mechanical Data**

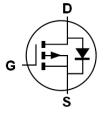
- Package: TO252
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.33 grams (Approximate)



TO252 (DPAK)

Top View





Internal Schematic

### Ordering Information (Note 4)

| Part Number   |                 | Paakaga      | Р     | Packing     |  |
|---|-----------------|--------------|-------|-------------|--|
|   | Part Number     | Package      | Qty.  | Carrier     |  |
|   | DMP45H4D9HK3-13 | TO252 (DPAK) | 2,500 | Tape & Reel |  |
| Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. |                 |              |       |             |  |

EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## Marking Information



 $\begin{array}{l} \bigcirc 1 \\ \Rightarrow 1 \\ \Rightarrow 1 \\ \Rightarrow 1 \\ \Rightarrow 2 \\$ 



### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                    | Symbol           | Value                     | Unit |              |    |
|---|------------------|---------------------------|------|--------------|----|
| Drain-Source Voltage                              | VDSS             | -450                      | V    |              |    |
| Gate-Source Voltage                               | V <sub>GSS</sub> | ±30                       | V    |              |    |
| Continuous Drain Current (Note 5) $V_{GS} = -10V$ | Steady<br>State  | Tc = +25°C<br>Tc = +100°C | lo   | -4.7<br>-3.0 | A  |
| Maximum Body Diode Forward Current (Note 5)       |                  | ls                        | -1.5 | A            |    |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1% | ldм              | -12                       | A    |              |    |
| Avalanche Current, L = 60mH (Note 7)              | las              | -2.5                      | А    |              |    |
| Avalanche Energy, L = 60mH (Note 7)               |                  |                           | Eas  | 187          | mJ |

### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic                                   |             | Symbol           | Value | Unit |  |
|--|-------------|------------------|-------|------|--|
| Total Bower Dissinction (Note E)                 | Tc = +25°C  | Tc = +25°C       |       | W    |  |
| Total Power Dissipation (Note 5)                 | Tc = +100°C | PD               | 41    | vV   |  |
| Thermal Resistance, Junction to Ambient (Note 6) | Reja        | 41               | °C/W  |      |  |
| Thermal Resistance, Junction to Case (Note 5)    |             | R <sub>0JC</sub> | 1.2   | -0/W |  |
| Operating and Storage Temperature Range          | TJ, TSTG    | -55 to +150      | °C    |      |  |

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                             | Symbol              | Min  | Тур  | Max  | Unit | Test Condition   |  |
|--|---------------------|------|------|------|------|--|--|
| OFF CHARACTERISTICS (Note 8)               |                     |      |      | •    |      | •  |  |
| Drain-Source Breakdown Voltage             | BVDSS               | -450 |      | _    | V    | $V_{GS} = 0V, I_D = -250 \mu A$                          |  |
| Zero Gate Voltage Drain Current            | IDSS                |      |      | -1   | μA   | $V_{DS} = -450V, V_{GS} = 0V$                            |  |
| Gate-Source Leakage                        | I <sub>GSS</sub>    |      |      | ±100 | nA   | $V_{GS} = \pm 30V, V_{DS} = 0V$                          |  |
| ON CHARACTERISTICS (Note 8)                |                     |      |      |      |      |  |  |
| Gate Threshold Voltage                     | VGS(TH)             | -3.0 | -4.0 | -5.0 | V    | $V_{DS} = V_{GS}$ , $I_D = -250 \mu A$                   |  |
| Static Drain-Source On-Resistance          | RDS(ON)             |      | 3.1  | 4.9  | Ω    | $V_{GS} = -10V, I_D = -1.05A$                            |  |
| Diode Forward Voltage                      | VSD                 |      |      | -1.4 | V    | $V_{GS} = 0V, I_{S} = -2.1A$                             |  |
| Forward Transconductance                   | gfs                 | _    | 1.4  | _    | S    | $V_{DS} = -50.0V, I_{D} = -1.05A$                        |  |
| DYNAMIC CHARACTERISTICS (Note 7)           |                     |      | •    |      |      | -  |  |
| Input Capacitance                          | Ciss                | _    | 564  | —    |      | V <sub>DS</sub> = -25V, V <sub>GS</sub> = 0V, f = 1.0MHz |  |
| Output Capacitance                         | Coss                |      | 70   | _    | pF   |  |  |
| Reverse Transfer Capacitance               | Crss                |      | 3.3  | _    |      |  |  |
| Total Gate Charge (V <sub>GS</sub> = -10V) | Qg                  | _    | 13.7 | —    |      |  |  |
| Gate-Source Charge                         | Qgs                 | _    | 3.4  | _    | nC   | $V_{DS} = -360V, I_D = -2.7A, V_{GS} = -10V$             |  |
| Gate-Drain Charge                          | Qgd                 | _    | 6.0  | —    |      |  |  |
| Turn-On Delay Time                         | tD(ON)              | _    | 21   | _    |      |  |  |
| Turn-On Rise Time                          | tR                  |      | 54   | _    |      | $V_{DD}$ = -225V, $R_G$ = 3.0 $\Omega$ , $I_D$ = -2.7A   |  |
| Turn-Off Delay Time                        | t <sub>D(OFF)</sub> |      | 34   |      | ns   |  |  |
| Turn-Off Fall Time                         | tF                  |      | 34   |      |      |  |  |
| Body Diode Reverse Recovery Time           | trr                 |      | 168  |      | ns   | $V_{GS} = 0V, V_{DD} = -200V, I_{S} = -2.7A,$            |  |
| Body Diode Reverse Recovery Charge         | Q <sub>RR</sub>     |      | 1.3  |      | μC   | dl/dt = 100A/µs  |  |

Notes:

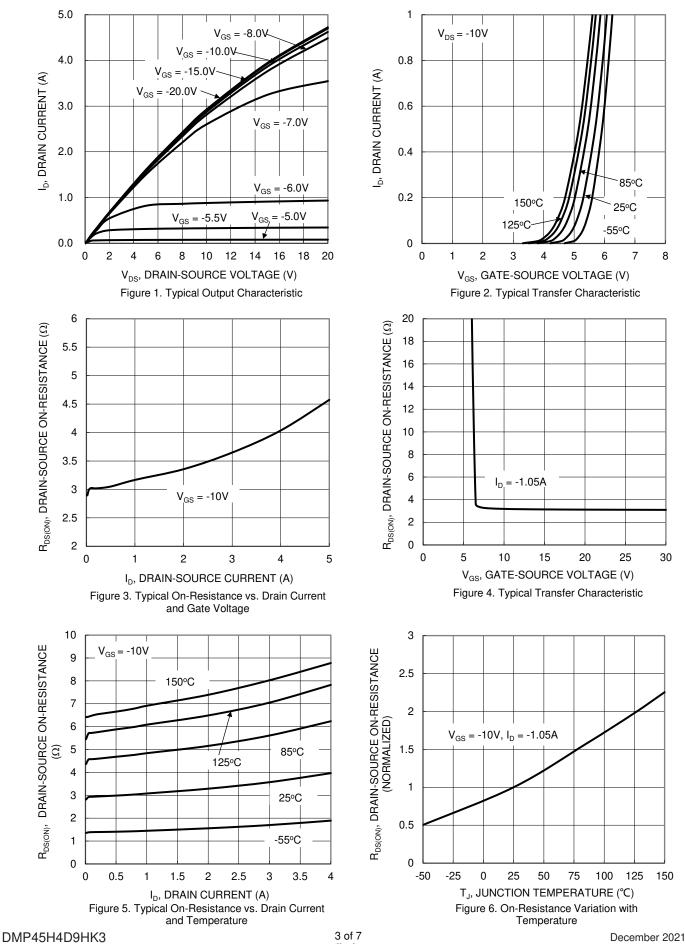
Device mounted on infinite heatsink.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.

7. Guaranteed by design. Not subject to production testing.

8. Short duration pulse test used to minimize self-heating effect.



### DMP45H4D9HK3



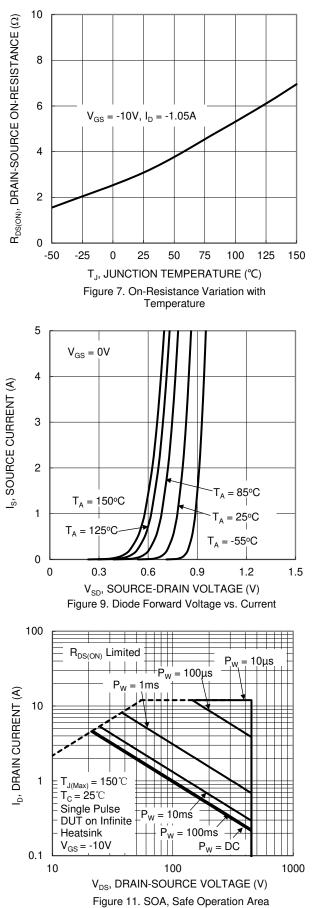
Document number: DS38850 Rev. 3 - 2

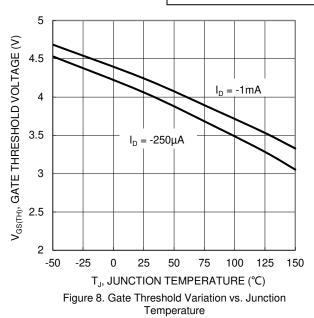
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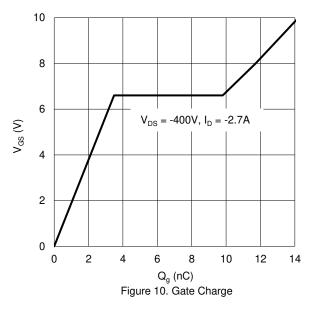
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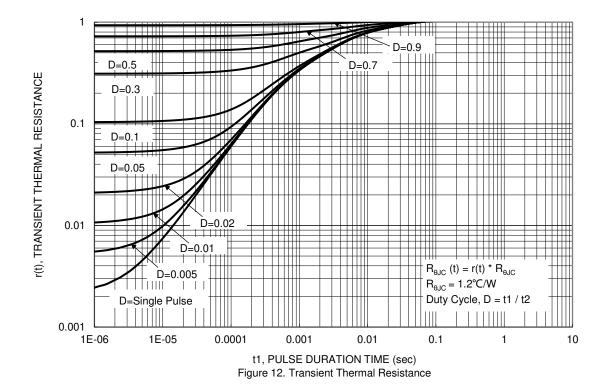
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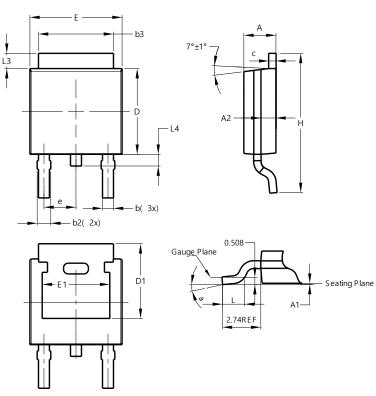






## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

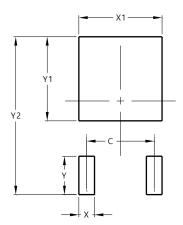


| TO252 (DPAK) |                      |       |       |  |  |  |
|--------------|----------------------|-------|-------|--|--|--|
| Dim          | Min                  | Max   | Тур   |  |  |  |
| Α            | 2.19                 | 2.39  | 2.29  |  |  |  |
| A1           | 0.00                 | 0.13  | 0.08  |  |  |  |
| A2           | 0.97                 | 1.17  | 1.07  |  |  |  |
| b            | 0.64                 | 0.88  | 0.783 |  |  |  |
| b2           | 0.76                 | 1.14  | 0.95  |  |  |  |
| b3           | 5.21                 | 5.46  | 5.33  |  |  |  |
| С            | 0.45                 | 0.58  | 0.531 |  |  |  |
| D            | 6.00                 | 6.20  | 6.10  |  |  |  |
| D1           | 5.21                 | -     | -     |  |  |  |
| е            | -                    | -     | 2.286 |  |  |  |
| Ε            | 6.45                 | 6.70  | 6.58  |  |  |  |
| E1           | 4.32                 | -     | -     |  |  |  |
| Н            | 9.40                 | 10.41 | 9.91  |  |  |  |
| L            | 1.40                 | 1.78  | 1.59  |  |  |  |
| L3           | 0.88                 | 1.27  | 1.08  |  |  |  |
| L4           | 0.64                 | 1.02  | 0.83  |  |  |  |
| а            | 0°                   | 10°   | -     |  |  |  |
| All          | All Dimensions in mm |       |       |  |  |  |

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TO252 (DPAK)



| Dimensions | Value (in mm) |
|------------|---------------|
| С          | 4.572         |
| Х          | 1.060         |
| X1         | 5.632         |
| Y          | 2.600         |
| Y1         | 5.700         |
| Y2         | 10.700        |



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